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Application Number

First Named Inventor Group Art Unit

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Filing Date

09/747,118

12/22/2000

2841

J. Alcala

Eldridge et al.

2/1997

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Substitute for form 1449A/PTO

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INFORMATION DISCLOSURE

STATEMENT BY APPLICANT

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¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵Applicant is to place a check mark here if English language Translation is attached.

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